

# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	Vrrm Vrwm Vr	70	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	49	V
Forward Continuous Current (Note 6)	I <sub>0</sub>	70	mA
Non-Repetitive Peak Forward Surge Current @ tp < 1.0s	I <sub>FSM</sub>	100	mA

## **Thermal Characteristics**

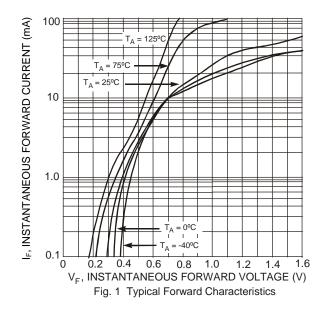
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	$P_{D}$	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ heta JA}$	625	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to +150	°C

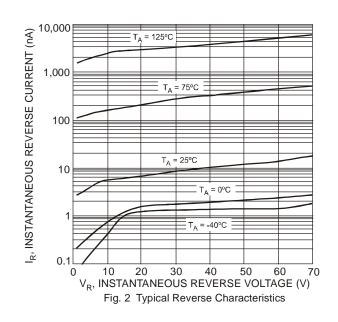
## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	70	_	_	$I_R = 10\mu A$
Forward Voltage	VF	_	410 1000	mV	$t_p < 300 \mu s$ , $I_F = 1.0 mA$ $t_p < 300 \mu s$ , $I_F = 15 mA$
Reverse Current (Note 7)	I <sub>R</sub>	_	100	nA	$t_p < 300 \mu s, V_R = 50 V$
Total Capacitance	Ст	_	2.0	pF	$V_R = 0V$ , $f = 1.0MHz$
Reverse Recovery Time	t <sub>RR</sub>	_	5.0	ns	$I_F = I_R = 10 \text{mA} \text{ to } I_R = 1.0 \text{mA},$ $I_{RR} = 0.1 \text{ x } I_R, R_L = 100 \Omega$

Notes:

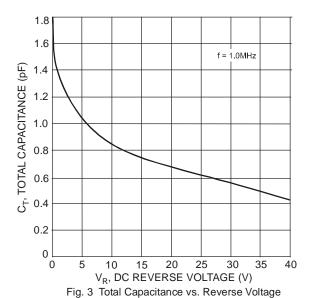
- 6. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.
- 7. Short duration pulse test used to minimize self-heating effect.

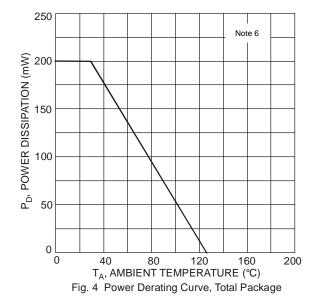










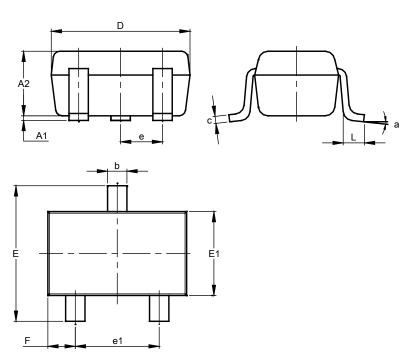




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT323**

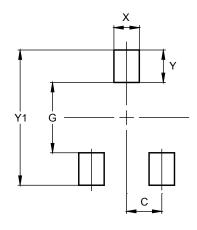


SOT323				
Dim	Min	Max	Тур	
A1	0.00	0.10	0.05	
A2	0.90	1.00	0.95	
b	0.25	0.40	0.30	
C	0.10	0.18	0.11	
D	1.80	2.20	2.15	
Е	2.00	2.20	2.10	
E1	1.15	1.35	1.30	
е	0.650 BSC			
e1	1.20	1.40	1.30	
F	0.375	0.475	0.425	
١	0.25	0.40	0.30	
а	0°	8°		
All Dimensions in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT323**



Dimensions	Value (in mm)
C	0.650
G	1.300
Х	0.470
Y	0.600
Y1	2 500



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